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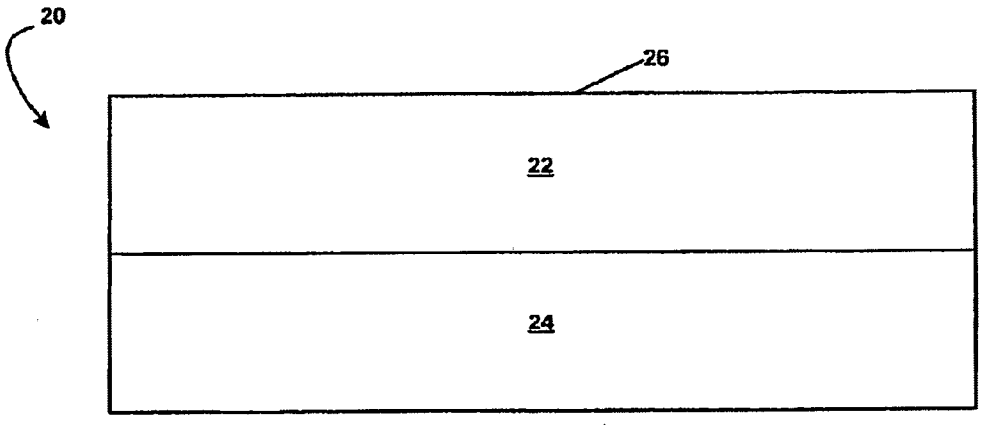
(54) Title: POLISHING PAD WITH SURFACE ROUGHNESS



(57) Abstract: A polishing pad has a polishing layer having a polishing surface with a surface roughness between about 200 and 300 microinches. The polishing pad can be made by forming a polishing layer by extrusion or molding, and grinding a polishing surface of the polishing layer to a surface roughness between about 200 and 300 microinches.

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